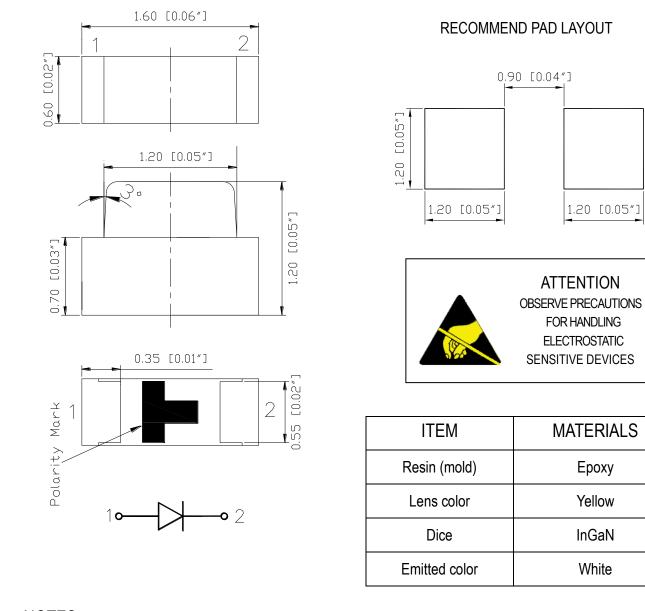
X190 Series SMD Chip LED Lamps

Part Number: N0W19S86SV

Package outlines



NOTES:

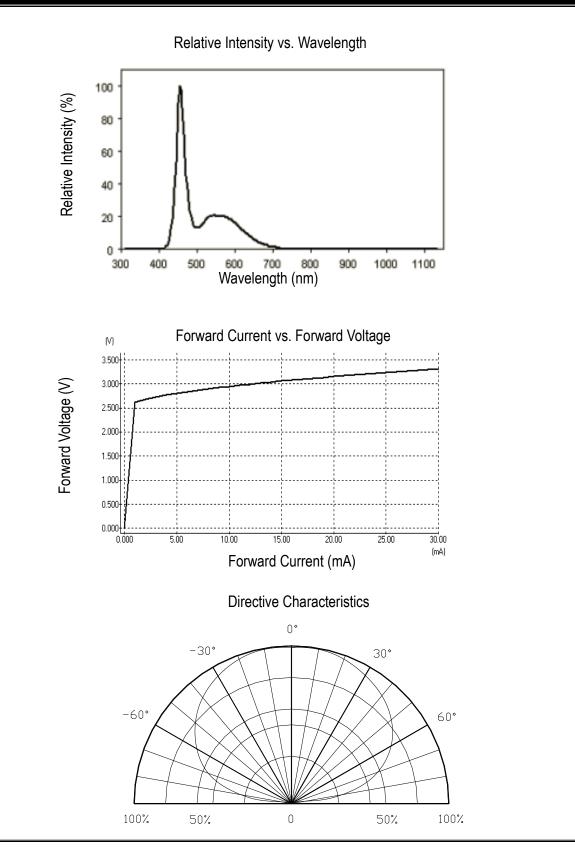
- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are $\pm 0.1 \text{mm}$ (0.004inch) unless otherwise noted.

Rev :	Date	Drawn by :	Checked by :	Approved by :	
A	2013/08/28	唐明芮	許媚鳳	黃靜文	

Part Number: N0W19S86SV

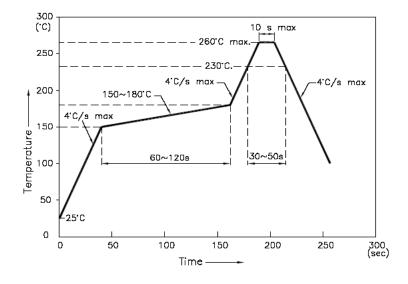
Absolute maximum ratings (T _A =25°C)						
Parameter	Symbol	Value			Unit	
Forward current	lf	30			mA	
Reverse voltage	Vr	5			V	
Power dissipation	Pd	111			mW	
Operating temperature range	Тор	-40 ~+80			°C	
Storage temperature range	Tstg	-40 ~+85			°C	
Peak pulsing current (1/8 duty f=1kHz)	lfp	125			mA	
Electro-optical characteristics (T _A =25°C)						
Parameter	Test	Symbol	Value			Unit
Farameter	Condition	Gymbol	Min	Тур	Max	
CIE Coordinates	lf=20mA	X Y		0.28 0.29		
Forward voltage	lf=20mA	Vf	2.8	3.1	3.7	V
Luminous intensity	lf=20mA	lv	160	250	500	mcd
Viewing angle at 50% Iv	lf=10mA	201/2		140		Deg
Reverse current	Vr=5V	lr			10	μΑ

Part Number: N0W19S86SV OPTICAL CHARACTERISTIC CURVES



Reflow Profile

Reflow Temp/Time



NOTES:

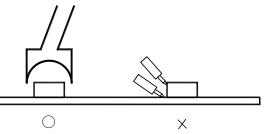
- 1. We recommend the reflow temperature 245 °C (±5 °C).the maximum soldering temperature should be limited to 260 °C.
- 2. dont cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

■Soldering iron

Basic spec is \leq 5sec when 260°C. If temperature is higher, time should be shorter (+10°C \rightarrow -1sec).Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

■Rework

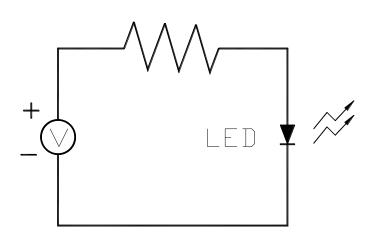
- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron can not touch copper foil
- 3. Twin-head type is preferred.



Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

Test circuit and handling precautions

Test circuit



- Handling precautions
- 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Shelf life in sealed bag: 12 month at $5^{\circ}C \sim 30^{\circ}C$ and < 60% R.H;
- 3. After the package is Opened:
- 3.1. It is recommended to baking before the first use:

Baking condition:

a. 60 \pm 3°C x (36~48hrs) and < 5%RH, taped reel type ;

b. $110\pm3^{\circ}$ C x (8~16hr), bulk type ;

3.2 The products should be used within a week or they should be keeping to stored at *≦*20 R.H. with zip-lock sealed:

a. It is recommended to baking before soldering when the pack is unsealed after 72hrs ;

b. Baking condition as 3.1 baking condition.

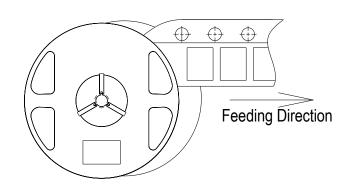
Test items and results of reliability

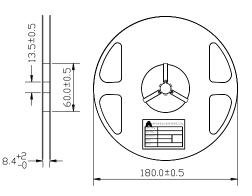
Туре	Test Item	Test Conditions	Note	Number of Damaged	
	Temperature Cycle	-20°⊂ 30min ↑↓ 80°⊂ 30min	100 cycle	0/22	
	Thermal Shock	-20°⊂ 15min ↑↓ 80°⊂ 15min	100 cycle	0/22	
Environmental Sequence	High Humidity Heat Cycle	30°C⇔ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22	
	High Temperature Storage	Ta=80°⊂	1000 hrs	0/22	
	Humidity Heat Storage	T _a =60°⊂ RH=90%	1000 hrs	0/22	
	Low Temperature Storage	T₂=-30°C	1000 hrs	0/22	
Operation Sequence	Life Test	T _a =25°⊂ I _F =20mA	1000 hrs	0/22	
	High Humidity Heat Life Test 60°⊂ RH=900 I _F =10mA		500 hrs	0/22	
	Low Temperature Life Test T _a =-20°⊂ I _F =20mA		1000 hrs	0/22	

X190 Series SMD Chip LED Lamps Packaging Specifications

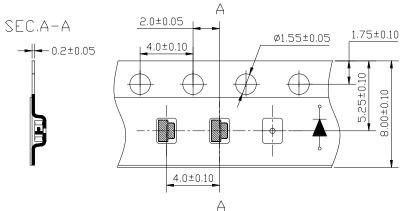
• Feeding Direction

• Dimensions of Reel (Unit: mm)

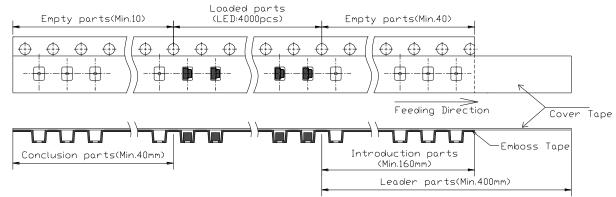




• Dimensions of Tape (Unit: mm)



• Arrangement of Tape



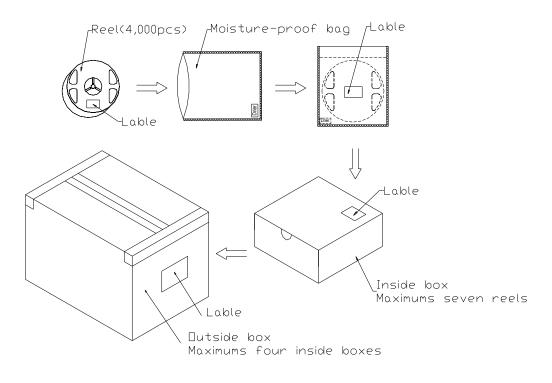
NOTES

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 4,000 pcs/Reel

PACKAGING SPECIFICATIONS

X190 Series SMD Chip LED Lamps Packaging Specifications

• Packaging specifications



NOTES:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, Seven moisture-proof bag of maximums (total maximum number of products are 28,000pcs) packed in an inside box (size: about 238mm x about 194mm x about 102mm) and four inside boxes of maximums are put in the outside box (size: about 410mm x about 254mm x about 229mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the root the loading steps of outside box (cardboard box) has it to three steps.

SURFACE	MOU	JNT LE	ED L	AMP	S			
Part Number: I	N0W19	S86SV						
Forward Voltage	Rank	Combinat	ion (IF	=20mA				
Rank	Min.					Unit		
f		2.8				3.1		
g		3.1				V		
h		3.4				3.7		
Luminous Intens	sity Ra	nk Combi	nation	(IF=20r	nA)			
Rank	Min.				Max.	Unit		
L		160				200		
М	200			250		mcd		
Ν	250			320				
0	320			400				
Р		400				500	-	
Chromaticity cod	ordinat	es Ranks	combi	ination	(IF=20m	A)		
Rank			(Chromati	city coor	dinates		
_	Х	0.25		0.25		0.27	0.27	
D	Y	0.24	0.24		31	0.31	0.24	
_	Х	0.27	1	0.	27	0.29	0.29	
E	Y	0.25		0.32		0.32	0.25	
F	Х	0.29			29	0.31	0.31	
F	Y	0.26		0.33		0.33	0.26	
0	Х	0.31		0.31		0.33	0.33	
G	Y	Y 0.27		0.34		0.34	0.27	
Group Name on	Label	(Exam	ple DA	TA: gN	Ξ 20)			
DATA: gNE 20		Vf(V)	lv	(mcd)	CIE(X,Y)		Test Condition	
g→N→E→20		3.1~3.4 250~32		0~320	X(0.27	Z~0.29),Y(0.25~0.32)	IF=20mA	

1. The tolerance of luminous intensity (Iv)is $~\pm15\,\%$.

2. The tolerance of Chromaticity coordinates is ± 0.02 .

3. This specification is preliminary.